



Product Change Notification

104828 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

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Product Change Notification

Change Notification #: 104828 - 00
Change Title: Intel® NetStructure™ ZT 5524 High-Performance System Master Processor Board, PCN 104828-00, FYI, Solder side cover and label changes
Date of Publication: February 15, 2005

Type of Change Notification:

FYI - (For Your Information)

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Feb 28, 2005
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Description of Change to the Customer:

1. Solder side cover changed from A61809-001 to C88612-001.

- New transparent cover is more durable and rugged compared to the previous black opaque material which was too rigid and prone to tear/break at the faceplate screw edges.

- Additional cut-outs have been implemented on the solder cover edge along the front faceplate to improve fitting.

- Screw mounting holes have been fabricated on the solder side cover to alleviate the need to remove the solder side cover when mounting hard disk drives to the board.

2. Safety label changed from A89748-007 to A89748-008 (ZT5524A1A & ZT5524A1B).

Additional marks to the label for Japan, Australia, New Zealand and Korea. We now have approvals for all of these countries for Pozo.

Customer Impact of Change and Recommended Action:

Customer must be ready to receive post-conversion change.

Further customer validation might be required but Intel has completed Full Qualification on the changes.

Products Affected / Intel Ordering Codes:

Board Products Table

Affected Product Code	Pre-Change MM#	Post-Change MM#	Pre-Change TA or AA	Post-Change TA or AA	Pre-Change PBA	Post-Change PBA
MPCBL5524A1C 861266	861266	861266	C88607-003	C88607-004		
MPCBL5524A1D 861110	861110	861110	C88462-003	C88462-004		
ZT5524A1A 843737	843737	843737	A68370-019	A68370-020		
ZT5524A1B 843738	843738	843738	A68371-018	A68371-019		

Reference Documents / Attachments:

Document:

Location #:

PCN Revision History:

Date of Revision:

February 15, 2005

Revision Number:

00

Reason:

Originally Published PCN